



Attorney Docket No. 5649-1149

PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re: Jin-Sung Chung Confirmation No.: 5932
Serial No.: 10/644,462 Examiner: Lynne Ann Gurley
Filed: August 20, 2003 Group Art Unit: 2812
For: METHODS FOR FORMING METAL INTERCONNECTIONS FOR
SEMICONDUCTOR DEVICES USING A BUFFER LAYER ON A
TRENCH SIDEWALL, AND SEMICONDUCTOR DEVICES SO FORMED

May 27, 2004

Mail Stop Issue Fee
Commissioner for Patents
Box 1450
Alexandria, VA 22313-1450

AMENDMENT AFTER ALLOWANCE PURSUANT TO 37 CFR 1.312

Sir:

Applicants provide the present Amendment in response to the Notice of Allowance dated May 14, 2004.

It is not believed that an extension of time and/or additional fee(s)-including fees for net addition of claims-are required, beyond those that may otherwise be provided for in documents accompanying this paper. In the event, however, that an extension of time is necessary to allow consideration of this paper, such an extension is hereby petitioned under 37 CFR §1.136(a). Any additional fees believed to be due in connection with this paper may be charged to our Deposit Account No. 50-0220.

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In the Title:

Please amend the title as follows:

METHODS FOR FORMING METAL INTERCONNECTIONS FOR
SEMICONDUCTOR DEVICES USING A BUFFER LAYER ON A
TRENCH SIDEWALL, AND SEMICONDUCTOR DEVICES SO FORMED